

# Hi-Flo 2000

Core Bake Oven flux, Header Dip  
flux, Torch and Repair Soldering  
Flux

## TYPICAL PROPERTIES

Appearance: Mobil Clear Amber  
Liquid  
Weight: 10.58 LBS/GAL  
pH: < 2.0

## Description

HI- FLO 2000 provides greater solder penetration. Burns clean thus provides leaner surface resulting in a better core, easier to paint. Better tolerance to open torch heat, reduces charring on parts.

## Recommended Application

1

HI- FLO 2000 super concentrate may be applied by a cascade or immersion. Dilution Recommendation Water:Flux Core Bake - 16:1- 20:1. Header Dip - 3:1- 5:1. Torch Soldering - 1:1 - 3:1. Repairs 3:1 - 6:1.

2

It is recommended that the flux residues be removed after soldering operations.

## Benefits

- \* Used with wide range of solder.
- \* Superior cleaning ability for removal of lubricants, shop dirt and oxides.
- \* High employee acceptance, no offensive odor.
- \* Excellent shelf life.

## Health & Safety

Please refer to SDS for complete health and safety information.

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